



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



MA4X174 (MA174)

Silicon planar type

For small power rectification and surge absorption

■ Features

- Two isolated elements contained in one package, allowing high-density mounting
- High breakdown voltage: $V_R = 200$ V

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit	
Reverse voltage	V_R	200	V	
Repetitive peak reverse voltage	V_{RRM}	250	V	
Non-repetitive peak reverse surge voltage	V_{RSM}	300	V	
Output current	Single	I_O	100	mA
	Double		75	
Repetitive peak forward current	Single	I_{FRM}	225	mA
	Double		170	
Non-repetitive peak forward surge current *	Single	I_{FSM}	500	mA
	Double		375	
Junction temperature	T_j	125	$^\circ\text{C}$	
Storage temperature	T_{stg}	-55 to +125	$^\circ\text{C}$	

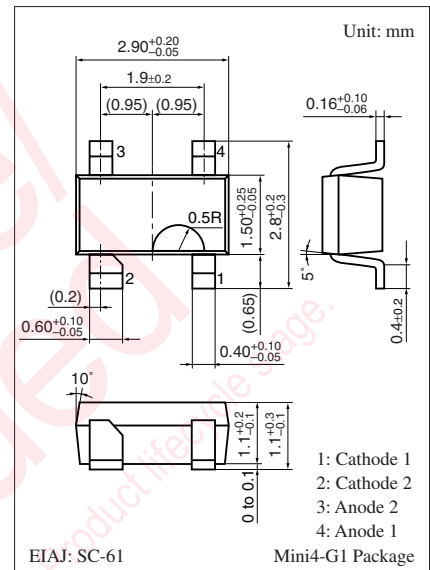
Note) *: $t = 1$ s

■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	V_F	$I_F = 100$ mA			1.3	V
Reverse current	I_R	$V_R = 200$ V			1.0	μA

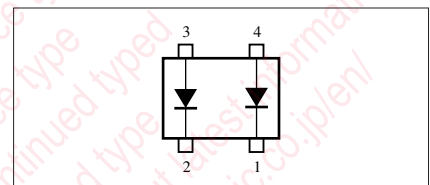
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 3 MHz.

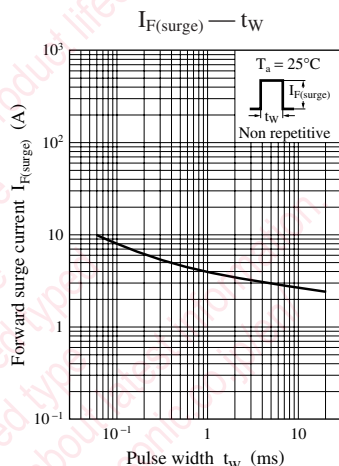
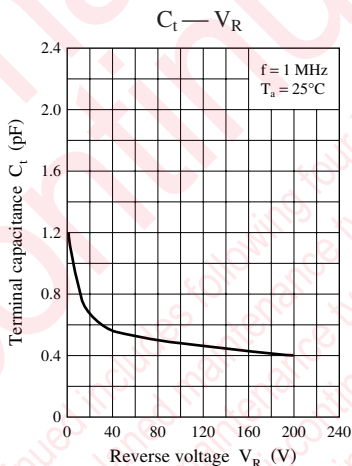
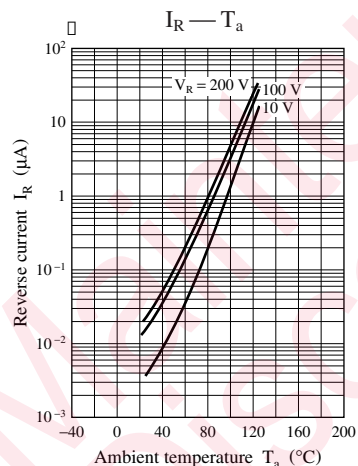
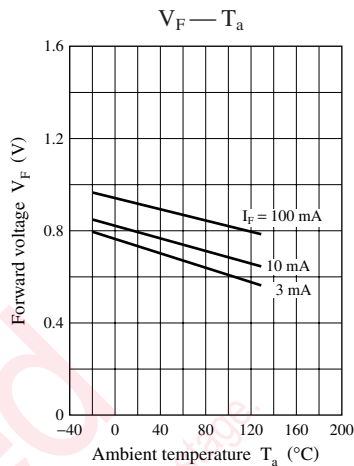
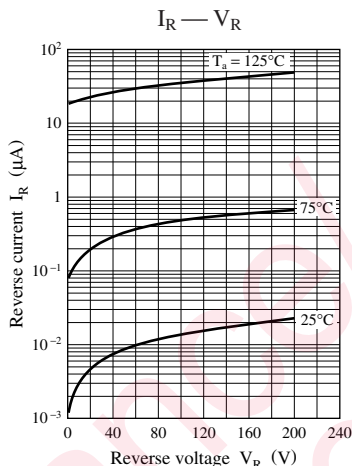
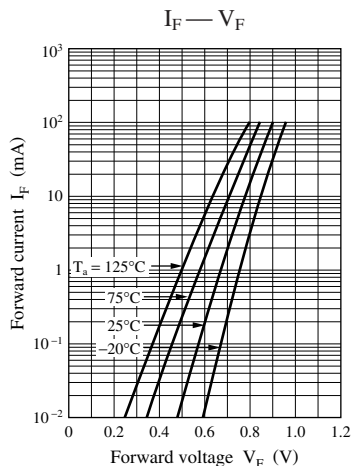


Marking Symbol: M20

Internal Connection



Note) The part number in the parenthesis shows conventional part number.



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